

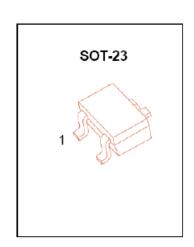
Taiwan Goodark Technology Co.,Ltd

CESD5V0AP

ESD Protection Diodes

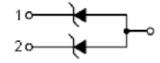
DESCRIPTION

The CESD5V0AP is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.



FEATURES

- Stand-off Voltage: 3.3 V-12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- These are Pb-Free Devices



Maximum Ratings @T_A=25°C

Parameter	Symbol	Limits	Unit	
IEC61000-4-2(ESD)	Air		±15	ΚV
	Contact		±8.0	ΝV
ESD voltage per hu	voltage per human body model			
Total power dissipation on FR-5 board (Note	PD	225	mW	
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	556	°C/W	
Lead Solder Temperature - Maximum (10 Se	TL	260	°C	
Junction and Storage temperature range	T _j , T _{stg}	-55 ~ +150	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended. Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. $FR-5 = 1.0 \times 0.75 \times 0.62 \text{ in.}$



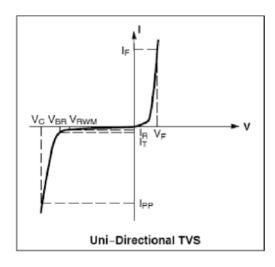
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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

UNIDIRECTIONAL (Circuit tied to Pins 1 and 3 or 2 and 3)

Symbol	Parameter					
I _{PP}	Maximum Reverse Peak Pulse Current					
V _C	Clamping Voltage @ I _{PP}					
V _{RWM}	Working Peak Reverse Voltage					
IR	Maximum Reverse Leakage Current @ V _{RWM}					
V _{BR}	Breakdown Voltage @ I _T					
I _T	Test Current					
I _F	Forward Current					
V _F	Forward Voltage @ I _F					
P _{pk}	Peak Power Dissipation					
С	Max. Capacitance @V _R =0 and f =1MHz					



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}\text{C}$ unless otherwise noted, $V_F = 0.9 \text{ V Max.}$ @ $I_F = 10\text{mA}$ for all types)

Device*	Device Marking	V _{RWM} (V)	I _R (μA) @V _{RWM}	V _{BR} (\ @ I _T (No:		I _T	Vc @IPP =1 A	Max I _{PP} †	P _{pk} ⁺ (W)	C (pF) Pin 1 to 3
		Max	Max	Min	Max	mA	٧	Α	Max	Тур
CESD3V3AP	3M3	3.3	10	5.0	5.9	1.0	7.5	13.3	300	150
CESD5V0AP	5M	5	10	6.2	7.3	1.0	9.8	12	300	110
CESD12VAP	12M	12	1.0	13.3	15.75	1.0	19	11.2	300	60

^{*}Other voltages available upon request.

⁺Surge current waveform per Figure 3

^{2.} V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.